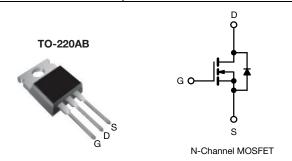
Vishay Siliconix

Power MOSFET

PRODUCT SUMMARY				
V _{DS} (V)	200			
$R_{DS(on)}(\Omega)$	V _{GS} = 5.0 V 0.18			
Q _g max. (nC)	66			
Q _{gs} (nC)	9.0			
Q _{gd} (nC)	38			
Configuration	Single			



FEATURES

- Dynamic dV/dt rating
- · Repetitive avalanche rated
- · Logic-level gate drive
- R_{DS(on)} specified at V_{GS} = 4 V and 5 V
- Fast switching
- · Ease of paralleling
- Simple drive requirements
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

Note

This datasheet provides information about parts that are RoHS-compliant and / or parts that are non-RoHS-compliant. For example, parts with lead (Pb) terminations are not RoHS-compliant. Please see the information / tables in this datasheet for details.

DESCRIPTION

Third generation power MOSFETs from Vishay provides the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost effectiveness.

The TO-220AB package is universally preferred for all commercial-industrial applications at power dissipation levels to approximately 50 W. The low thermal resistance and low package cost of the TO-220AB contribute to its wide acceptance throughout the industry.

ORDERING INFORMATION		
Package	TO-220AB	
Load (Dh) froe	IRL640PbF	
Lead (Pb)-free	SiHL640-E3	
SnPb	IRL640	
SIIPD	SiHL640	

ABSOLUTE MAXIMUM RATINGS (T _C :	= 25 °C, unl	ess otherwis	se noted)		
PARAMETER			SYMBOL	LIMIT	UNIT
Drain-Source Voltage			V _{DS}	200	
Gate-Source Voltage		V _{GS}	± 10	V	
Continuous Dunin Comment	V -+ 5 0 V	$T_{\rm C} = 25 ^{\circ}{\rm C}$ $T_{\rm C} = 100 ^{\circ}{\rm C}$		17	
Continuous Drain Current V _G		T _C = 100 °C	I _D	11	Α
Pulsed Drain Current ^a		I _{DM}	68		
Linear Derating Factor			1.0	W/°C	
Single Pulse Avalanche Energy b		E _{AS}	580	mJ	
Repetitive Avalanche Current ^a		I _{AR}	10	А	
Repetitive Avalanche Energy ^a		E _{AR}	13	mJ	
Maximum Power Dissipation	ximum Power Dissipation T _C = 25 °C		P _D	125	W
Peak Diode Recovery dV/dt c			dV/dt	5.0	V/ns
Operating Junction and Storage Temperature Range		T _J , T _{stg}	-55 to +150	- °C	
Soldering Recommendations (Peak temperature) ^d for 10 s			300		
Mounting Torque	6-32 or M3 screw			10	lbf ⋅ in
Mounting Torque				1.1	N⋅m

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11). b. $V_{DD}=50$ V, starting $T_J=25$ °C, L=3.0 mH, $R_q=25$ Ω $I_{AS}=17$ A (see fig. 12). c. $I_{SD}\leq17$ A, $dI/dt\leq150$ A/ms, $V_{DD}\leq V_{DS}$, $T_J\leq150$ °C.

- d. 1.6 mm from case.



Vishay Siliconix

THERMAL RESISTANCE RATINGS					
PARAMETER	SYMBOL	TYP.	MAX.	UNIT	
Maximum Junction-to-Ambient	R _{thJA}	-	62		
Case-to-Sink, Flat, Greased Surface	R _{thCS}	0.50	-	°C/W	
Maximum Junction-to-Case (Drain)	R _{thJC}	-	1.0		

PARAMETER	SYMBOL	TEST	CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static					Į.	ļ.	
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0$	V, I _D = 250 μA	200	-	-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference	to 25 °C, I _D = 1 mA	-	0.27	-	V/°C
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V$	' _{GS} , I _D = 250 μA	1.0	-	2.0	V
Gate-Source Leakage	I _{GSS}	V	_{GS} = ± 10	-	-	± 100	nA
Zava Oata Valta va Dusia Ozumant		$V_{DS} = 2$	00 V, V _{GS} = 0 V	-	-	25	μА
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 160 V, V	/ _{GS} = 0 V, T _J = 125 °C	-	-	250	
Dunin Course On Chata Basistana	Б	V _{GS} = 5.0 V	I _D = 10 A ^b	-	-	0.18	0
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} = 4.0 V	I _D = 8.5 A ^b	-	-	0.27	Ω
Forward Transconductance	9 _{fs}		0 V, I _D = 10 A b	16	-	_	S
Dynamic							
Input Capacitance	C _{iss}	V _{GS} = 0 V,		-	1800	-	pF
Output Capacitance	C _{oss}	V	$V_{DS} = 25 \text{ V}$		400	-	
Reverse Transfer Capacitance	C _{rss}	f = 1.0	MHz, see fig. 5	-	120	-	
Total Gate Charge	Qg			-	-	66	
Gate-Source Charge	Q _{gs}	V _{GS} = 5.0 V	$I_D = 17 \text{ A}, V_{DS} = 160 \text{ V},$ see fig. 6 and 13 b	-	-	9.0	nC
Gate-Drain Charge	Q _{gd}	7	See lig. 6 and 16	-	-	38	1
Turn-On Delay Time	t _{d(on)}			-	8.0	_	
Rise Time	t _r	$V_{DD} = 1$	00 V, I _D = 17 A	-	83	-	
Turn-Off Delay Time	t _{d(off)}	$V_{DD} = 100 \text{ V}, I_D = 17 \text{ A}$ - 83 - 83 - 84 - 85 - 84 - 85 - 85 - 85 - 85 - 85		-	ns		
Fall Time	t _f			-	52	-	1
Internal Drain Inductance	L_D	Between lead, 6 mm (0.25") from		-	4.5	-	
Internal Source Inductance	L _S	package and ce die contact	enter of	-	7.5	-	- nH
Gate Input Resistance	Rq	f = 1 M	Hz, open drain	0.3	-	1.2	Ω
Drain-Source Body Diode Characteristic	s						
Continuous Source-Drain Diode Current	I _S	MOSFET symbo	ol (-	-	17	^
Pulsed Diode Forward Current ^a	I _{SM}	integral reverse p - n junction di	1 (1:. 4\ F		-	68	A
Body Diode Voltage	V _{SD}	T _J = 25 °C, I	_S = 17 A, V _{GS} = 0 V ^b	-	-	2.0	V
Body Diode Reverse Recovery Time	t _{rr}	- 310 47		470	ns		
Body Diode Reverse Recovery Charge	Q _{rr}	$T_J = 25 ^{\circ}\text{C}$, $I_F = 17 \text{A}$, $dI/dt = 100 \text{A/µs}^{\text{b}}$ $\frac{1}{2} ^{\circ}$ $\frac{310}{2}$		4.8	μC		
Forward Turn-On Time	t _{on}	Intrinsic turn	-on time is negligible (turn	on is do	ninated b	v Le and	L _D)

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- b. Pulse width \leq 300 µs; duty cycle \leq 2 %.



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

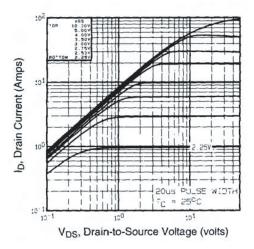


Fig. 1 - Typical Output Characteristics, T_C = 25 $^{\circ}C$

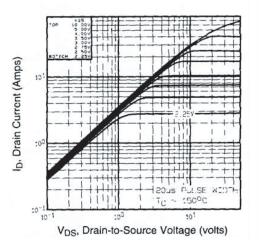


Fig. 2 - Typical Output Characteristics, $T_C = 150$ °C

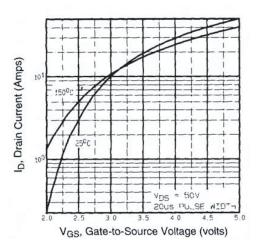


Fig. 3 - Typical Transfer Characteristics

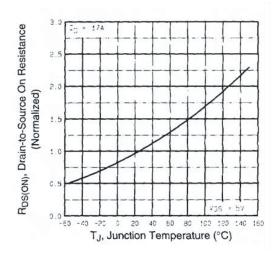


Fig. 4 - Normalized On-Resistance vs. Temperature



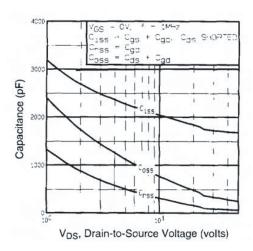


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

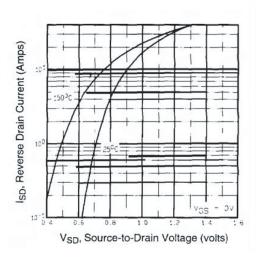


Fig. 7 - Typical Source-Drain Diode Forward Voltage

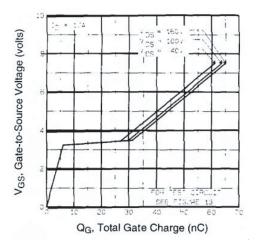


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

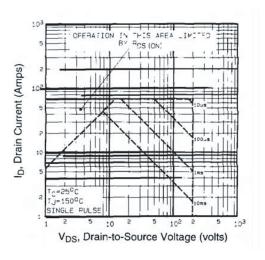


Fig. 8 - Maximum Safe Operating Area



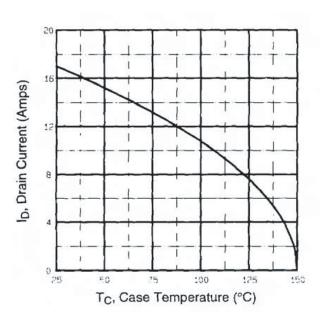


Fig. 9 - Maximum Drain Current vs. Case Temperature

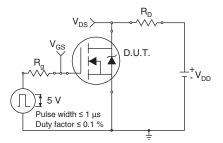


Fig. 10a - Switching Time Test Circuit

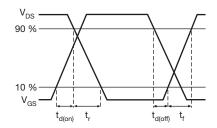


Fig. 10b - Switching Time Waveforms

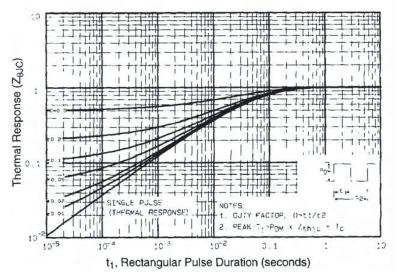


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case

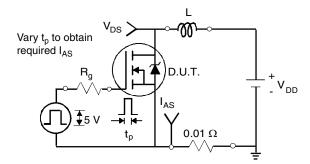


Fig. 12a - Unclamped Inductive Test Circuit

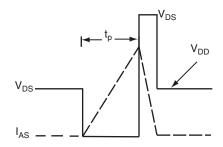


Fig. 12b - Unclamped Inductive Waveforms



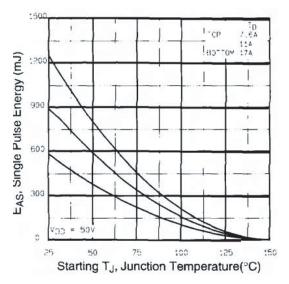


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

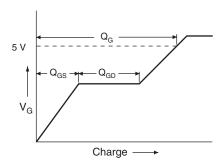


Fig. 13a - Basic Gate Charge Waveform

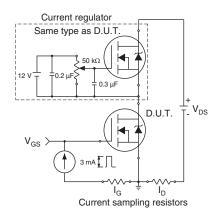
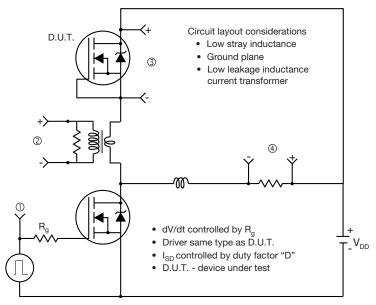


Fig. 13b - Gate Charge Test Circuit



Peak Diode Recovery dV/dt Test Circuit



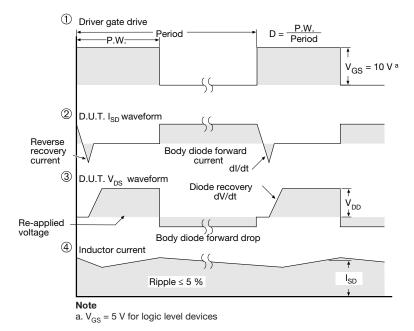


Fig. 14 - For N-Channel

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TO-220-1



DIM.	MILLIN	METERS	INCHES		
	MIN.	MAX.	MIN.	MAX.	
Α	4.24	4.65	0.167	0.183	
b	0.69	1.02	0.027	0.040	
b(1)	1.14	1.78	0.045	0.070	
С	0.36	0.61	0.014	0.024	
D	14.33	15.85	0.564	0.624	
Е	9.96	10.52	0.392	0.414	
е	2.41	2.67	0.095	0.105	
e(1)	4.88	5.28	0.192	0.208	
F	1.14	1.40	0.045	0.055	
H(1)	6.10	6.71	0.240	0.264	
J(1)	2.41	2.92	0.095	0.115	
L	13.36	14.40	0.526	0.567	
L(1)	3.33	4.04	0.131	0.159	
ØР	3.53	3.94	0.139	0.155	
Q	2.54	3.00	0.100	0.118	

Note

 \bullet $M^{\star}=0.052$ inches to 0.064 inches (dimension including protrusion), heatsink hole for HVM



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